

4V Drive Pch+SBD MOS FET

QS6U24

●Structure

Silicon P-channel MOS FET
Schottky Barrier DIODE

●Features

- 1) The QS6U24 combines Pch MOS FET with a Schottky barrier diode in a TSMT6 package.
- 2) Low on-state resistance with a fast switching.
- 3) Low voltage drive (4V).
- 4) Built-in schottky barrier diode has low forward voltage.

●Applications

Load switch, DC/DC conversion

●Packaging specifications

Type	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	3000
QS6U24		○

●Absolute maximum ratings (Ta=25°C)

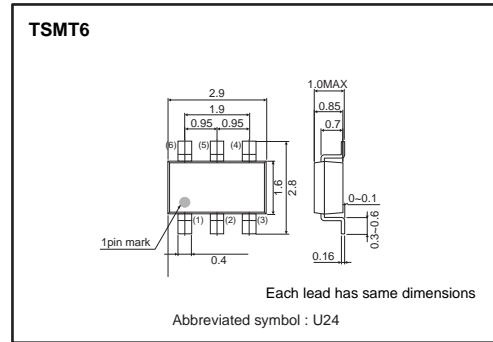
<MOSFET>				
Parameter	Symbol	Limits	Unit	
Drain-source voltage	V _{DSS}	-30	V	
Gate-source voltage	V _{GSS}	±20	V	
Drain current	Continuous	I _D	±1.0	A
	Pulsed	I _{DP} *1	±2.0	A
Source current (Body diode)	Continuous	I _S	-0.3	A
	Pulsed	I _{SP} *1	-1.2	A
Channel temperature	T _{ch}	150	°C	
Power dissipation	P _D *3	0.9	W/ELEMENT	

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Parameter	Symbol	Limits	Unit
Repetitive peak reverse voltage	V _{RM}	25	V
Reverse voltage	V _R	20	V
Forward current	I _F	0.7	A
Forward current surge peak	I _{FSM} *2	3.0	A
Junction temperature	T _J	150	°C
Power dissipation	P _D *3	0.7	W/ELEMENT

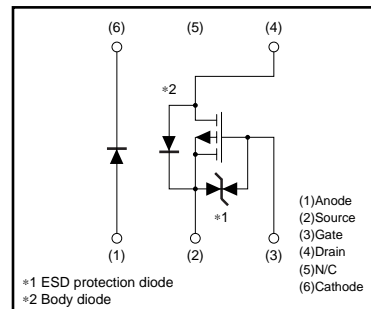
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Parameter	Symbol	Limits	Unit
Total power dissipation	P _D *3	1.25	W/TOTAL
Range of storage temperature	T _{stg}	-55 to +150	°C

*1 Pw≤10μs, Duty cycles≤1% *2 60Hz-1cyc. *3 Mounted on a ceramic board

●External dimensions (Unit : mm)



●Inner circuit



* A protection diode has been built in between the gate and the source to protect against static electricity when the product is in use. Use the protection circuit when rated voltages are exceeded.

Transistor

●Electrical characteristics (Ta=25°C)

<MOSFET>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	–	–	±10	μA	V _{GS} =±20V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR) DSS}	–30	–	–	V	I _D =–1mA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	–	–	–1	μA	V _{DS} =–30V, V _{GS} =0V
Gate threshold voltage	V _{GS(th)}	–1.0	–	–2.5	V	V _{DS} =–10V, I _D =–1mA
Static drain-source on-starte resistance	R _{DS(on)} *	–	300	400	mΩ	I _D =–1A, V _{GS} =–10V
		–	500	700	mΩ	I _D =–0.5A, V _{GS} =–4.5V
		–	600	800	mΩ	I _D =–0.5A, V _{GS} =–4V
Forward transfer admittance	Y _{fs} *	0.5	–	–	S	V _{DS} =–10V, I _D =–0.5A
Input capacitance	C _{iss}	–	90	–	pF	V _{DS} =–10V
Output capacitance	C _{oss}	–	25	–	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss}	–	16	–	pF	f=1MHz
Turn-on delay time	t _{d(on)} *	–	9	–	ns	I _D =–0.5A
Rise time	t _r *	–	7	–	ns	V _{DD} ≐–15V V _{GS} =–4.5V
Turn-off delay time	t _{d(off)} *	–	18	–	ns	R _L =30Ω
Fall time	t _f *	–	7	–	ns	R _G =10Ω
Total gate charge	Q _g	–	1.7	–	nC	V _{DD} ≐–15V
Gate-source charge	Q _{gs}	–	0.6	–	nC	V _{GS} =–5V
Gate-drain charge	Q _{gd}	–	0.4	–	nC	I _D =–1.0A

* Pulsed

<Body diode (source-drain)>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V _{SD}	–	–	–1.2	V	I _S =–0.3A, V _{GS} =0V

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Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage drop	V _F	–	–	0.49	V	I _F =0.7A
Reverse current	I _R	–	–	200	μA	V _R =20V

Transistor

●Electrical characteristic curves

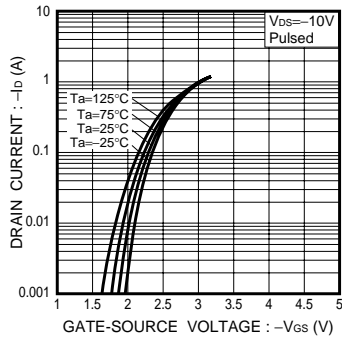


Fig.1 Typical Transfer Characteristics

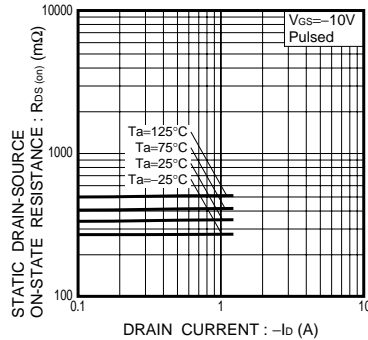


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (I)

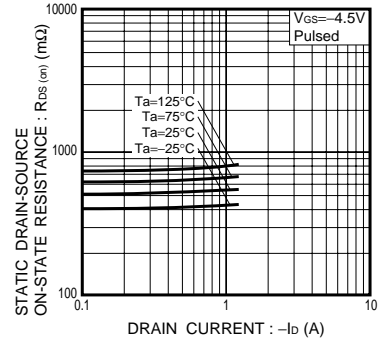


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (II)

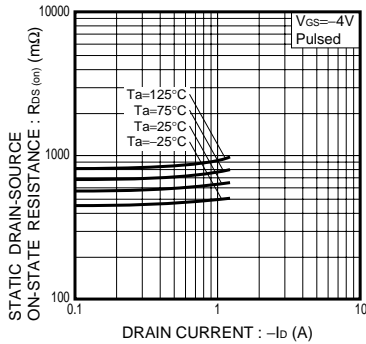


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (III)

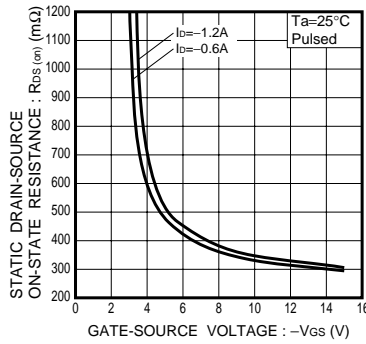


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

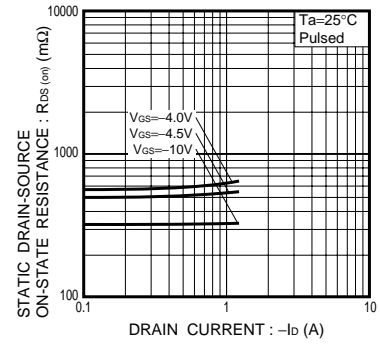


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current (IV)

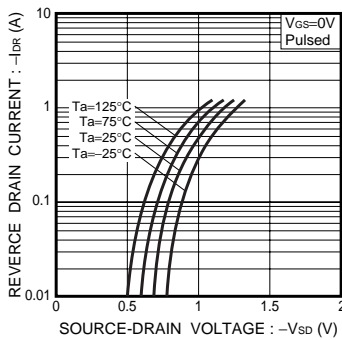


Fig.7 Reverse Drain Current vs. Source-Drain Voltage

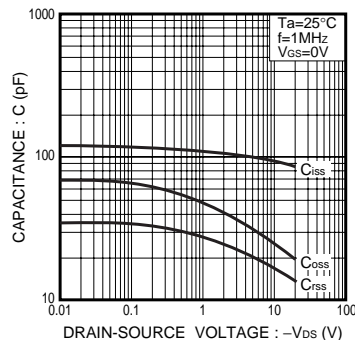


Fig.8 Typical Capacitance vs. Drain-Source Voltage

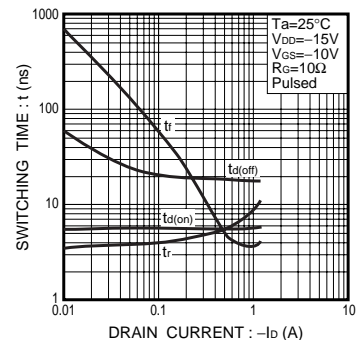


Fig.9 Switching Characteristics

Transistor

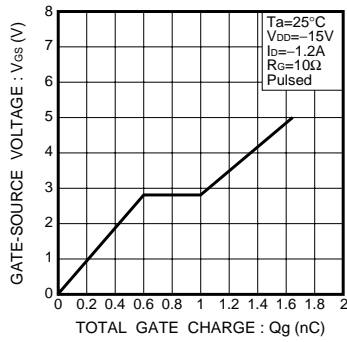


Fig.10 Dynamic Input Characteristics

●Measurement circuits

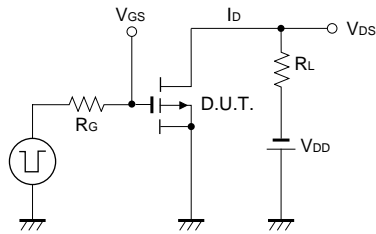


Fig.11 Switching Time Measurement Circuit

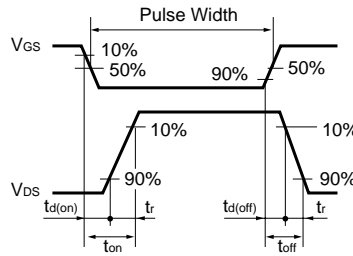


Fig.12 Switching Waveforms

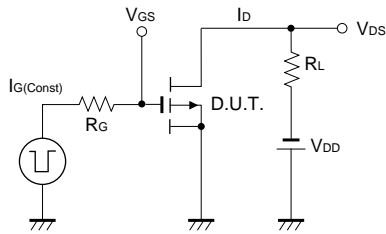


Fig.13 Gate Charge Measurement Circuit

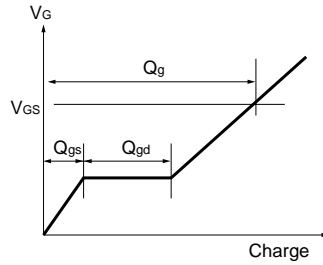


Fig.14 Gate Charge Waveforms

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